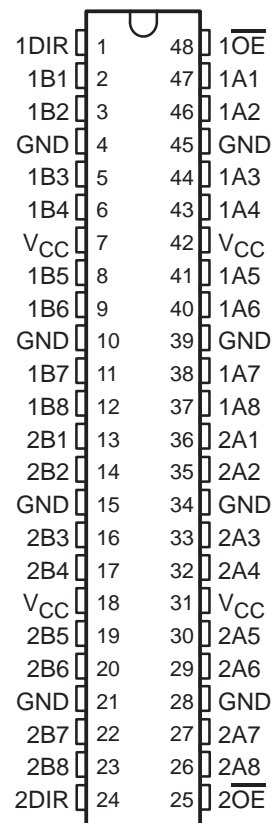


SN54ABT16640, SN74ABT16640 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS107C – APRIL 1992 – REVISED JANUARY 1997

- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs ($-32\text{-mA } I_{OH}$, $64\text{-mA } I_{OL}$)
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54ABT16640 . . . WD PACKAGE
SN74ABT16640 . . . DGG OR DL PACKAGE
(TOP VIEW)



description

The 'ABT16640 are inverting 16-bit transceivers designed for asynchronous communication between data buses.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (1DIR and 2DIR) inputs. The output-enable ($1\overline{OE}$ and $2\overline{OE}$) inputs can be used to disable the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16640 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT16640 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each 8-bit section)

| INPUTS | | OPERATION |
|-----------------|-----|------------------------------|
| \overline{OE} | DIR | |
| L | L | \overline{B} data to A bus |
| L | H | \overline{A} data to B bus |
| H | X | Isolation |



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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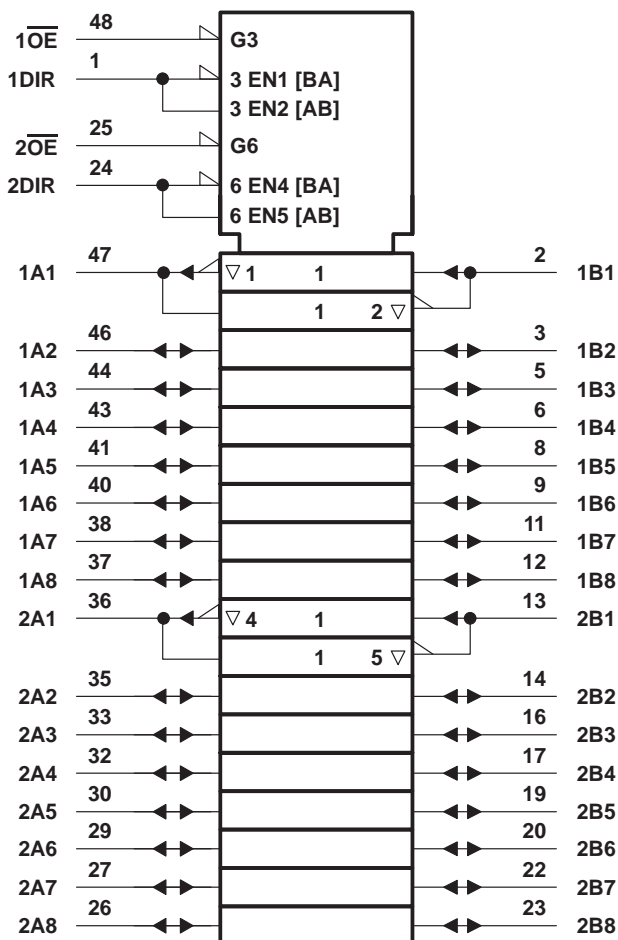
SN54ABT16640, SN74ABT16640

16-BIT BUS TRANSCEIVERS

WITH 3-STATE OUTPUTS

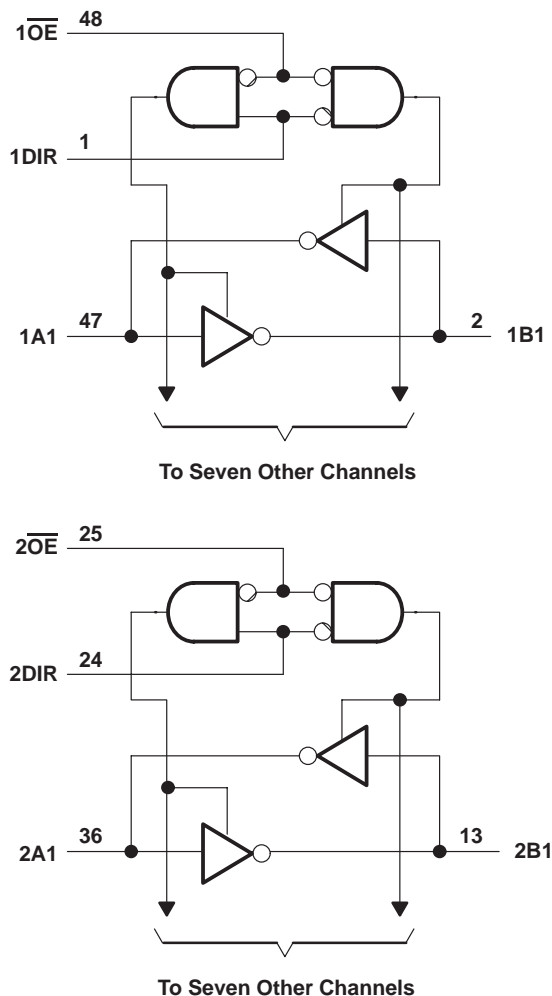
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|---|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (except I/O ports) (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V_O | –0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABT16640 | 96 mA |
| SN74ABT16640 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DGG package | 89°C/W |
| DL package | 94°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

SN54ABT16640, SN74ABT16640
16-BIT BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 3)

| | | | SN54ABT16640 | | SN74ABT16640 | | UNIT |
|-----------------|------------------------------------|-----------------|--------------|-----------------|--------------|-----------------|------|
| | | | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V _{IH} | High-level input voltage | | 2 | | 2 | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | 0.8 | V |
| V _I | Input voltage | | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | | | –24 | | –32 | mA |
| I _{OL} | Low-level output current | | | 48 | | 64 | mA |
| Δt/Δv | Input transition rise or fall rate | Outputs enabled | | 10 | | 10 | ns/V |
| T _A | Operating free-air temperature | | –55 | 125 | –40 | 85 | °C |

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | T _A = 25°C | | | SN54ABT16640 | | SN74ABT16640 | | UNIT | |
|--------------------|----------------|--|---|--------------------------|------|-------|--------------|------|--------------|------|------|----|
| | | | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | | |
| V _{IK} | | V _{CC} = 4.5 V, I _I = -18 mA | | -1.2 | | | -1.2 | | -1.2 | | V | |
| V _{OH} | | V _{CC} = 4.5 V, I _{OH} = -3 mA | | 2.5 | | | 2.5 | | 2.5 | | V | |
| | | V _{CC} = 5 V, I _{OH} = -3 mA | | 3 | | | 3 | | 3 | | | |
| | | V _{CC} = 4.5 V | | I _{OH} = -24 mA | | | 2 | | | | | |
| | | | | I _{OH} = -32 mA | | | 2* | | 2 | | | |
| V _{OL} | | V _{CC} = 4.5 V | | I _{OL} = 48 mA | | 0.55 | | 0.55 | | V | | |
| | | | | I _{OL} = 64 mA | | 0.55* | | 0.55 | | | | |
| V _{hys} | | | | 100 | | | | | | | mV | |
| I _I | Control inputs | V _{CC} = 5.5 V, V _I = V _{CC} or GND | | ±1 | | | ±1 | | ±1 | | μA | |
| | A or B ports | | | ±100 | | | ±100 | | | | | |
| I _{OZH} ‡ | | V _{CC} = 5.5 V, V _O = 2.7 V | | 50 | | | 50 | | 50 | | μA | |
| I _{OZL} ‡ | | V _{CC} = 5.5 V, V _O = 0.5 V | | -50 | | | -50 | | -50 | | μA | |
| I _{off} | | V _{CC} = 0, V _I or V _O ≤ 4.5 V | | ±100 | | | | | ±100 | | μA | |
| I _{CEX} | | V _{CC} = 5.5 V, V _O = 5.5 V | | Outputs high | | 50 | | 50 | | 50 | | μA |
| I _O § | | V _{CC} = 5.5 V, V _O = 2.5 V | | -50 | -100 | -180 | -40 | -180 | -50 | -180 | mA | |
| I _{CC} | A or B ports | V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND | | Outputs high | | 2 | | 2 | | 2 | | mA |
| | | | | Outputs low | | 32 | | 32 | | 32 | | |
| | | | | Outputs disabled | | 2 | | 2 | | 2 | | |
| ΔI _{CC} ¶ | Data inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | Outputs enabled | | 1 | | 1.5 | | 1 | | mA |
| | | | | Outputs disabled | | 0.05 | | 0.05 | | 0.05 | | |
| | Control inputs | | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | 1.5 | | | 1.5 | | 1.5 | | |
| C _i | Control inputs | V _I = 2.5 V or 0.5 V | | 3 | | | | | | | pF | |
| C _{io} | A or B ports | V _O = 2.5 V or 0.5 V | | 8 | | | | | | | pF | |

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

SN54ABT16640, SN74ABT16640
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN54ABT16640 | | | | | UNIT |
|------------------|-----------------|----------------|---|-----|-----|-----|-----|------|
| | | | V _{CC} = 5 V, T _A = 25°C | | | MIN | MAX | |
| | | | MIN | TYP | MAX | | | |
| t _{PLH} | A or B | B or A | 0.5 | 2.5 | 4.1 | 0.5 | 5.2 | ns |
| t _{PHL} | | | 0.5 | 2.8 | 4 | 0.5 | 4.5 | |
| t _{PZH} | \overline{OE} | A or B | 0.5 | 3.5 | 5.2 | 0.5 | 6.2 | ns |
| t _{PZL} | | | 0.5 | 3.9 | 6 | 0.5 | 7.4 | |
| t _{PHZ} | \overline{OE} | A or B | 0.5 | 3.8 | 6.8 | 0.5 | 7.9 | ns |
| t _{PLZ} | | | 0.5 | 3 | 4.5 | 0.5 | 5 | |

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | SN74ABT16640 | | | | | UNIT |
|------------------|-----------------|----------------|---|-----|-----|-----|-----|------|
| | | | V _{CC} = 5 V, T _A = 25°C | | | MIN | MAX | |
| | | | MIN | TYP | MAX | | | |
| t _{PLH} | A or B | B or A | 1 | 2.5 | 3.4 | 1 | 4.3 | ns |
| t _{PHL} | | | 1.1 | 2.8 | 3.6 | 1.1 | 3.9 | |
| t _{PZH} | \overline{OE} | A or B | 1.2 | 3.5 | 4.5 | 1.2 | 5.5 | ns |
| t _{PZL} | | | 1.5 | 3.9 | 5 | 1.5 | 6.3 | |
| t _{PHZ} | \overline{OE} | A or B | 1.8 | 3.8 | 4.8 | 1.8 | 6.3 | ns |
| t _{PLZ} | | | 1.5 | 3 | 3.9 | 1.5 | 4.2 | |

SN54ABT16640, SN74ABT16640

16-BIT BUS TRANSCEIVERS

WITH 3-STATE OUTPUTS

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PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |



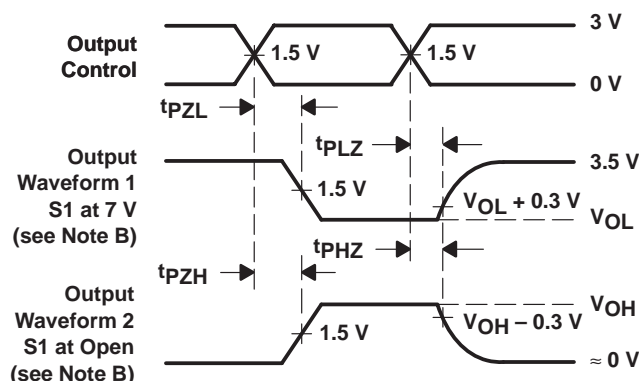
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN74ABT16640DGGR | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16640 |
| SN74ABT16640DGGR.B | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16640 |
| SN74ABT16640DL | Active | Production | SSOP (DL) 48 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16640 |
| SN74ABT16640DL.B | Active | Production | SSOP (DL) 48 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16640 |
| SN74ABT16640DLR | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16640 |
| SN74ABT16640DLR.B | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16640 |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ABT16640DGGR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74ABT16640DLR | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT16640DGGR | TSSOP | DGG | 48 | 2000 | 356.0 | 356.0 | 45.0 |
| SN74ABT16640DLR | SSOP | DL | 48 | 1000 | 356.0 | 356.0 | 53.0 |

TUBE

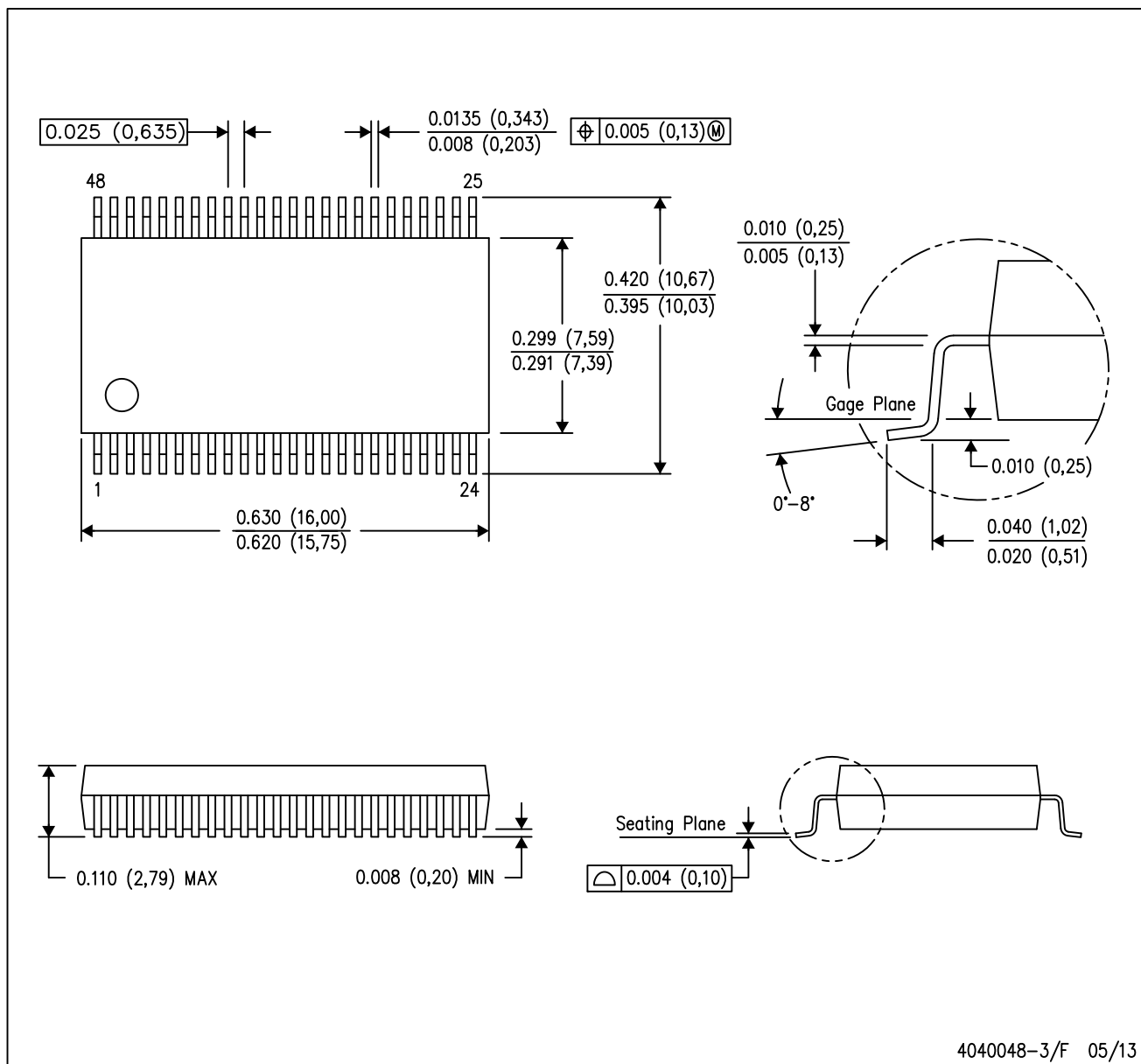


*All dimensions are nominal

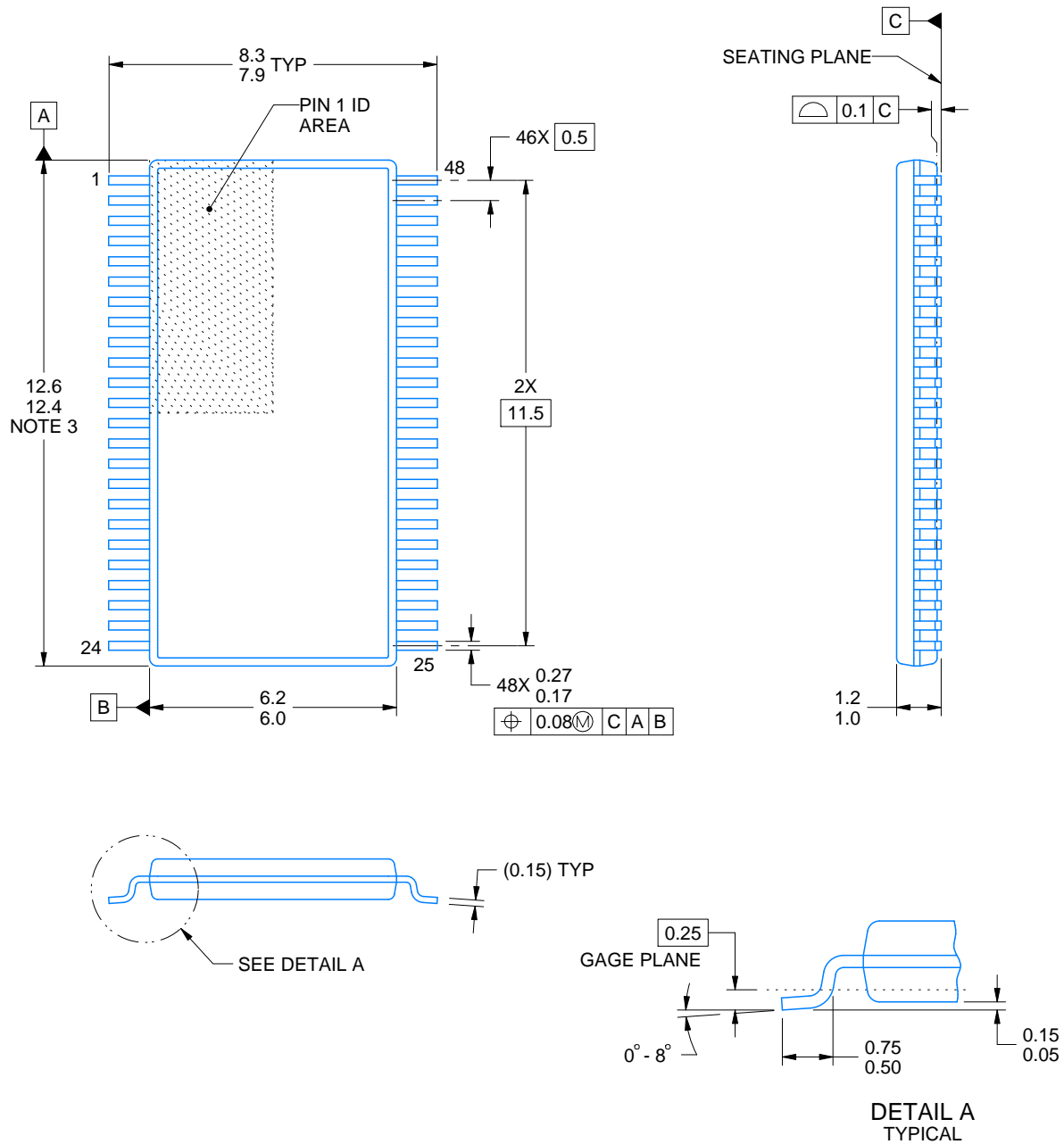
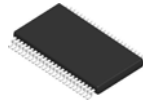
| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ABT16640DL | DL | SSOP | 48 | 25 | 473.7 | 14.24 | 5110 | 7.87 |
| SN74ABT16640DL.B | DL | SSOP | 48 | 25 | 473.7 | 14.24 | 5110 | 7.87 |

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MO-118



4214859/B 11/2020

NOTES:

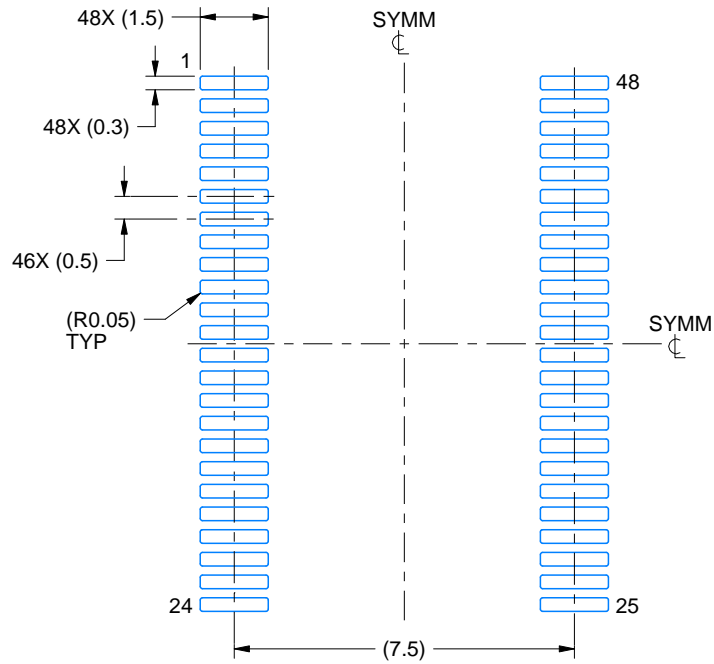
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

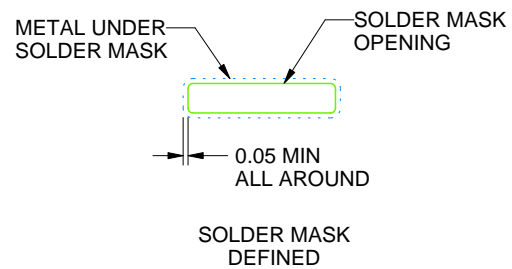
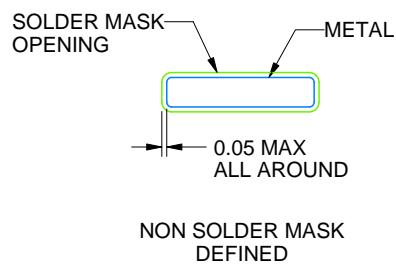
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

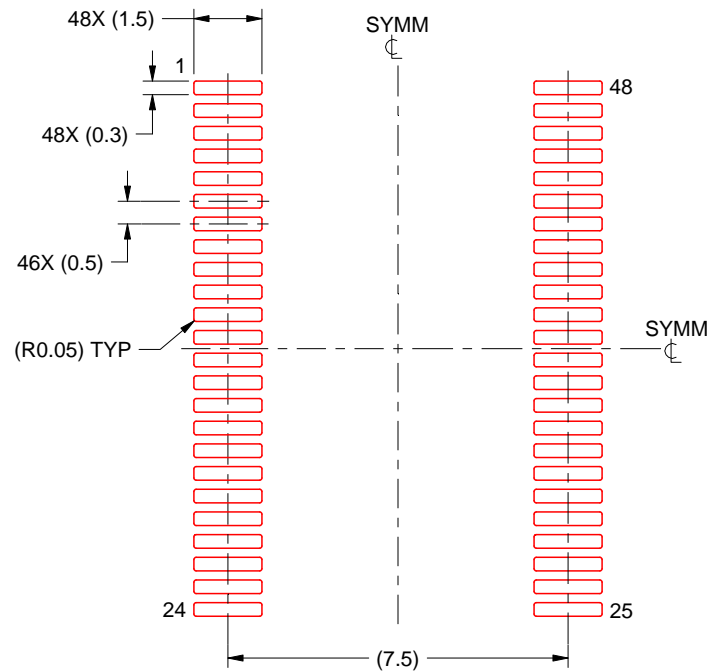
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4214859/B 11/2020

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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